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April 1st, 2010 Renesas Electronics Corporation

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SILICON POWER TRANSISTOR 2SB1261-Z

PNP SILICON EPITAXIAL TRANSISTOR

DESCRIPTION

The 2SB1261-Z is designed for Audio Frequency Amplifier and Switching, especially in Hybrid Integrated Circuits.

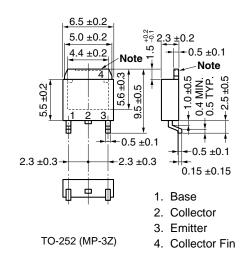
FEATURES

- High hFE hFE = 100 to 400
- Low V_{CE(sat)} V_{CE(sat)} ≤ 0.3 V

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Collector to Base Voltage	Vсво	-60	V	
Collector to Emitter Voltage	VCEO	-60	V	
Emitter to Base Voltage	VEBO	-7.0	V	
Collector Current (DC)		-3.0	А	
Collector Current (pulse) Note 1	C(pulse)	-5.0	А	
Base Current (DC)	B(DC)	-0.5	А	
Total Power Dissipation (T_A = $25^{\circ}C$) ^{Note 2}	P T1	2.0	W	
Total Power Dissipation (Tc = 25° C)	P _{T2}	10	W	
Junction Temperature	Tj	150	°C	
Storage Temperature	Tstg	-55 to +150	°C	

PACKAGE DRAWING (Unit: mm)



Note The depth of notch at the top of the fin is from 0 to 0.2 mm.

Notes 1. PW \leq 10 ms, Duty Cycle \leq 50%

2. When mounted on ceramic substrate of 7.5 $\text{cm}^2 \times 0.7 \text{ mm}$

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The mark <R> shows major revised points.

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The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

ELECTRICAL CHARACTERISTICS (Ta = 25 °C)

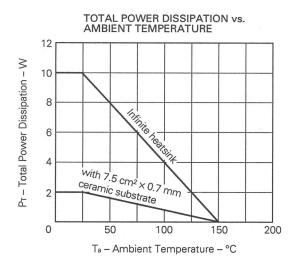
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Collector Cutoff Current	Ісво		197 - 192 K	-10	μA	Vсв = -60 V, IE = 0
Emitter Cutoff Current	Іево			-10	μΑ	VEB = -7.0 V, Ic = 0
DC Current Gain	hfe1*	60				Vce = -2.0 V, lc = -0.2 A
DC Current Gain	hfe2*	100		400		Vce = -2.0 V, Ic = -0.6 A
DC Current Gain	hfe3*	50				Vce = -2.0 V, lc = -2.0 A
Collector Saturation Voltage	VCE(sat)*		-0.2	-0.3	V	Ic = -1.5 А, Iв = -0.15 А
Base Saturation Voltage	VBE(sat)*		-0.94	-1.2	V	Ic = -1.5 А, Iв = -0.15 А
Gain Bandwidth Product	fτ		50		MHz	Vce = -5.0 V, Ie = 1.5 A
Output Capacitance	Сов		40		pF	Vсв = −10 V, IE = 0, f ≒ 1.0 MH
Turn-on Time	ton		0.15	0.5	μs	
Storage Time	tstg		0.5	2.0	μs	lc = −1.0 A, Vcc ≒ −10 V,
Fall time	tr		0.1	0.5	μs	RL = 10 Ω, IB1 = -IB2= -0.1 A

* Pulsed: PW \leq 350 μ s, Duty Cycle \leq 2 %

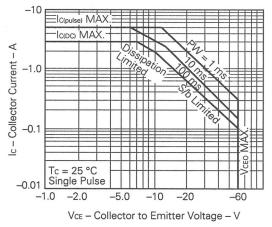
hre Classification

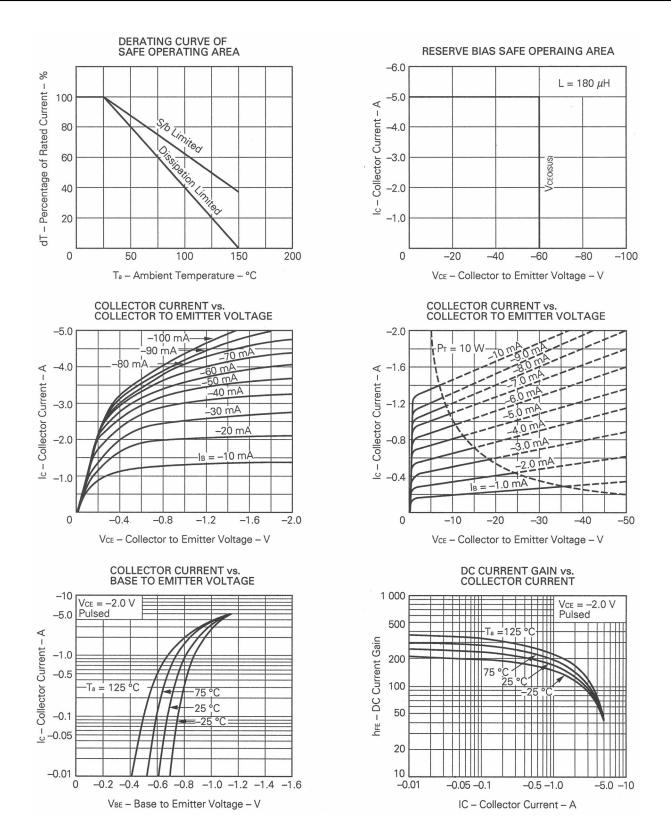
MARKING	М	L	К	
hfe2	100 to 200	160 to 320	200 to 400	

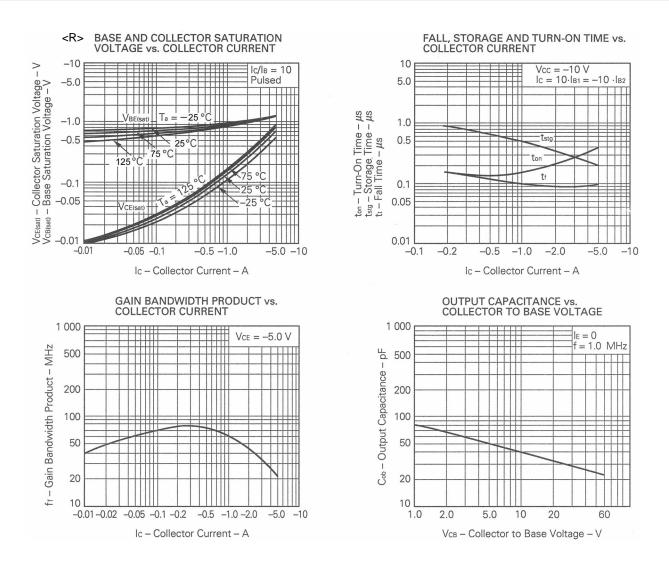
TYPICAL CHARACTERISTICS (Ta = 25 °C)



FORWARD BIAS SAFE OPERATING AREA







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